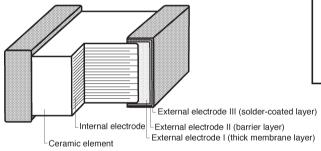
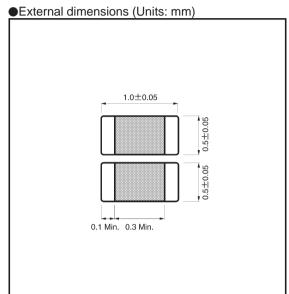
# Multi-layer ceramic chip capacitors MCH15 (1005 (0402) size, chip capacitor)

#### Features

- 1) Small size (1.0 x 0.5 x 0.5 mm) makes it perfect for lightweight portable devices.
- 2) Comes packed either in tape to enable automatic mounting or in bulk cases.
- Precise uniformity of shape and dimensions facilitates highly efficient automatic mounting.
- Solder-coated terminals offer superior solder bility and resistance to soldering heat.

### Structure



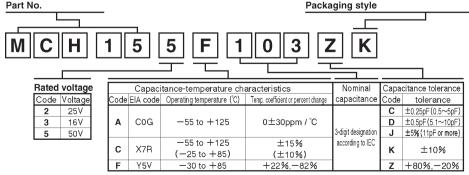


## Product Designation

Code	Product thickness	Packaging specifications	Reel	Basic ordening un
K	0.5mm	Paper tape (width 8 mm, pitch 2 mm)	φ180mm (7in.)	10,000
L	0.5mm	Paper tape (width 8 mm, pitch 2 mm)	φ330mm (13in.)	50,000
С	0.5mm	Bulk case	_	50,000
		K 0.5mm L 0.5mm	L 0.5mm Paper tape (width 8 mm, pitch 2 mm)	K         0.5mm         Paper tape (width 8 mm, pitch 2 mm)         \$\phi\$180mm (7in.)           L         0.5mm         Paper tape (width 8 mm, pitch 2 mm)         \$\phi\$30mm (13in.)

Reel (\$\phi\$180, \$\phi\$30mm) :compatible with EIAJ ETX-7001

Bulk case: according to EIAJ ET-7201A



<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.

# ■Capacitance range

For thermal compensation

Part n	MCH15	
	Temperature characteristics	(C0G)
Capacitance (pF)	Rated voltage (V) Tolerance	50V
0.5 0.75 1		
1.1 1.2 1.3		
1.5 1.6 1.8		
2 2.2 2.4	C(±0.25pF)	
2.7 3 3.3		
3.6 3.9 4		
4.3 4.7 5		
5.1 5.6 6		
6.2 6.8 7	D(±0.5pF)	
7.5 8 8.2	D(±0.3pi)	
9 9.1 10		
11 12 13		
15 16 18		
20 22 24	J (±5%)	
27 30 33		
36 39 43		

Part n	MCH15	
Capacitance (pF)	Temperature characteristics	(C0G)
Capacitance (pr.)	Rated voltage (V) Tolerance	50V
47 51 56 62 68 75 82 91 100 110 120 130 150 160 180 200 220 240 270 300 330 360 390 430 470 510 560	J (±5%)	

Product thickness (mm) 0.5±0.05

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.

# ■Capacitance range

High dielectric constant

Part n	MCH15						
	Temperature characteristics	C (X7R)		F (Y5V)			
Capacitance (pF)	Rated voltage (V)	50V	25V	16V	50V	25V	16V
	Tolerance	ı	〈(±10%)		Z (	+80, -20	%)
220 270 330							
390 470 560							
680 820 1,000							
1,200 1,500 1,800							
2,200 2,700 3,300							
3,900 4,700 5,600							
6,800 8,200 10,000 (0.01µF)							
12,000 15,000 18,000							
22,000 27,000 33,000							
39,000 47,000 56,000							
68,000 82,000 100,000 (0.1µF)							
120,000 150,000 180,000							
220,000 270,000 330,000							
390,000 470,000 560,000							

Product thickness (mm) 0.5±0.05

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.

## Characteristics

Class 1 (For thermal compensation)

Temperature characteristics		A (COG) Test methods/conditions			
Item		A (COG)	(based on JIS C 5102)		
Operating temperature		−55°C ~+125°C			
Nominal capacitance (C)		Must be within the specified tolerance range.	Based on paragraph 7.8 and paragraph 9 Measured at room temperature and standard humidity,		
Dissipation factor ( $\tan\delta$ )		100/(400+20C)% or less: Less than 30 pF 0.1% or less: 30 pF or larger	1000pF or less Measurement frequency : 1±0.1MHz Measurement voltage : 1±0.1Vrms.  Over 1000pF Measurement frequency : 1±0.1kHz Measurement voltage : 1±0.1Vrms.		
Insulation resistance (IR)		10,000 M $\Omega$ or larger, or 500 $\Omega$ F or larger, whichever is smaller	Based on paragraph 7.6 Measurement is made after rated voltage is applied for 60±5s		
Withstanding voltage		The insulation must not be damaged.	Based on paragraph 7.1 Apply 300% of the rated voltage for 1 to 5s then measure.		
Temperature characteristics		Within 0±30ppm/°C	The temperature coefficients in table 12, paragraph 7.12 are calculated at 20 °C and high temperature.		
Terminal adherence		No detachment or signs of detachment.	Based on paragraph 8.11. 2.  Apply 5N (0.51 kg · f) for 10±1s in the direction indicated by the arrow.  Pressure (5N)  Capacitor  Capacitor		
	Appearance	There must be no mechanical damage.	Chip is mounted to a board in the manner		
Resistance to vibration	Rate of capacitance change	Must be within initial tolerance.	shown on the right, subjected to vibration (type A in paragraph 8.2), and measured		
	tan δ	Must satisfy initial specified value.	24±2 hrs. later.		
Solderability		At least 3/4 of the surface of the two terminals must be covered with new solder.	Based on paragraph 8.13 Soldering temperature: 235±5°C Soldering time : 2±0.5s		
	Appearance	There must be no mechanical damage.			
	Rate of capacitance change	$\pm$ 2.5% or less, or $\pm$ 0.25 pF or less, whichever is larger.	Based on paragraph 8.14.		
Resistance to soldering	tan δ	Must satisfy initial specified value.	Soldering temperature: 260±5°C		
heat	Insulation resistance	10,000 M $\Omega$ or larger, or 500 $\Omega$ F or larger, whichever is smaller	Soldering time : 5±0.5s Preheating : 150±10°C for 1 to 2 min.		
	Withstanding voltage	The insulation must not be damaged.			
	Appearance	There must be no mechanical damage.			
	Rate of capacitance change	$\pm$ 2.5% or less, or $\pm$ 0.25 pF or less, whichever is larger.	Based on paragraph 9.3		
Temperature cycling	tan δ	Must satisfy initial specified value.	Number of cycles: 10		
, 0	Insulation resistance	10,000 M $\Omega$ or larger, or 500 $\Omega$ F or larger, whichever is smaller	Capacitance measured after 24±2 hrs.		
Humidity load test	Appearance	There must be no mechanical damage.	Based on paragraph 9.9		
	Rate of capacitance change	$\pm$ 7.5% or less, or $\pm$ 0.75 pF or less, whichever is larger.	Test temperature: 40±2°C Relative humidity: 90% to 95%		
	tan δ	0.5% or less	Applied voltage : rated voltage		
	Insulation resistance	500 M $\Omega$ or larger, or 25 $\Omega$ F or larger, whichever is smaller	Test time : 500 to 524 hrs. Capacitance measured after 24±2 hrs.		
High- temperature load test	Appearance	There must be no mechanical damage.	Based on paragraph 9.10		
	Rate of capacitance change	$\pm 3.0\%$ or less, or $\pm 0.3$ pF or less, whichever is larger.	Test temperature: Max. operating temp.		
	tan ∂	0.3% or less	Applied voltage : rated voltage x 200% Test time : 1,000 to 1,048 hrs.		
	Insulation resistance	1,000 MΩ or larger, or 50 ΩF or larger, whichever is smaller	Capacitance measured after 24±2 hrs.		

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.



## Characteristics

Class 2 (High dielectric constant)

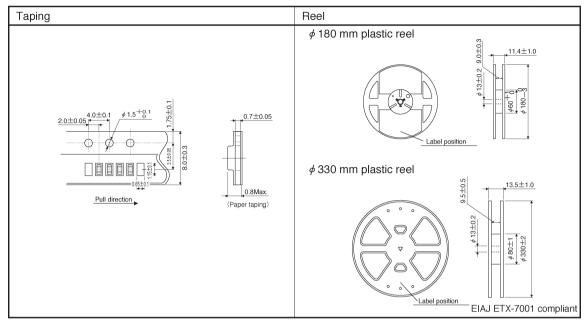
Temperature characteristics		C (X7R)	F (Y5V)	Test methods/conditions (based on JIS C 5102)	
Operating temperature		-55°C∼+125°C	-30°C∼+85°C		
Nominal capacitance (C)		Must be within the specified tolerance range.		Based on paragraph 7.8  Measured at room temperature and standard humidity	
Tanδ		2.5% or less (when rated voltage is 16V: 3.5% or less)	5.0% or less (when rated voltage is 16V: 7.5% or less)	Measurement frequency: 1 $\pm$ 0.1 kHz Measurement voltage : 1.0 $\pm$ 0.2 Vrms.	
Insulation resistance (IR)		$10{,}000~M\Omega$ or larger, or 500 $\Omega F$ or larger, whichever is smaller		Based on paragraph 7.6 Measurement is made after rated voltage is applied for 60±5s.	
Withstanding voltage		The insulation must not be damaged.		Based on paragraph 7.1 Apply 250% of the rated voltage for 1 to 5s then measure	
Temperature characteristics		Within ±15%	+22, -82%	The temperature coefficients in paragraph 7.12, table 8, condition B, are based on measurements carried out at 20°C, with no voltage applied.	
Terminal adherence		No detachment or signs of detachment		Based on paragraph 8. 11. 2. Apply 5N (0.51 kg • f) for 10±1s in the direction indicated by the arrow.	
	Appearance	There must be no mechanical damage.		Chip is mounted to a board in the manner shown on the right, subjected to vibration (type A in paragraph 8.2),	
Resistance to vibration	Rate of capacitance change	Must be within initial tolerance.			
	Dissipation factor	Must satisfy initia	Il specified value.	and measured 48±4 hrs. later. Board	
Solderability		At least 3/4 of the surface of the two terminals must be covered with new solder.		Based on paragraph 8. 13  Soldering temperature: 235 ±5°C  Soldering time : 2±0.5s	
	Appearance	There must be no mechanical damage.			
	Rate of capacitance change	Within ±5.0% Within ±20.0%		- Based on paragraph 8. 14.	
Resistance to soldering	Dissipation factor	Must satisfy initial specified value.		Soldering temperature: 260±5°C	
heat	Insulation resistance	10,000 MΩ or larger, or 500 ΩF or larger, whichever is smaller		Soldering time $:5\pm0.5s$ Preheating $:150\pm10^{\circ}C$ for $1$ to 2 min.	
	Withstanding voltage	The insulation mus			
	Appearance	There must be no n			
Temperature	Rate of capacitance change	Within ±7.5%	Within ±20.0%	Based on paragraph 9.3 Number of cycles: 10	
cycling	Dissipation factor	Must satisfy initial specified value.		Capacitance measured after 48 $\pm$ 4 hrs.	
	Insulation resistance	10,000 M $\Omega$ or larger, or 500 $\Omega$	F or larger, whichever is smaller		
	Appearance	There must be no n	nechanical damage.	Based on paragraph 9.9	
	Rate of capacitance change	±12.5% or less	Within ±30.0%	Test temperature: 40 ±2℃	
Humidity load test	Dissipation factor	5.0% or less	7.5% or less (when rated voltage is 16V: 10.0%)	Relative humidity: 90% to 95% Applied voltage : rated voltage Test time : 500 to 524 hrs.	
	Insulation resistance	500 MΩ or larger, or 25 ΩF or larger, whichever is smaller		Capacitance measured after 48 $\pm$ 4	
High- temperature load test	Appearance	There must be no mechanical damage.			
	Rate of capacitance change	Within ±10.0%	Within ±30.0%	Based on paragraph 9.10	
	Dissipation factor	5.0% or less	7.5% or less (when rated voltage is 16V: 10.0%)	Test temperature: Max. operating temp. Applied voltage : rated voltage x 200% Test time : 1,000 to 1,048 hrs.	
	Insulation resistance	1,000MΩ or larger, or 50 ΩF or larger, whichever is smaller		Capacitance measured after 48 ±4	

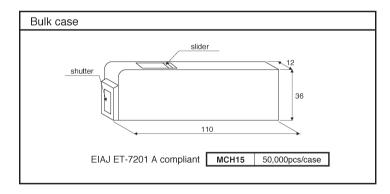
<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.



## Packaging specifications

(Unit: mm)





<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.

#### Electrical characteristics

#### ■A (C0G) Characteristics

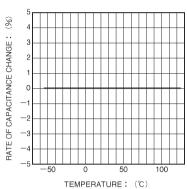


Fig.1 Capacitance-temperature characteristics

## C (X7R) Characteristics

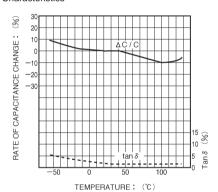


Fig.3 Capacitance-temperature characteristics

## F (Y5V) Characteristics

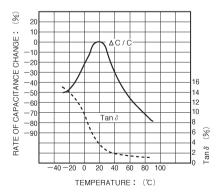


Fig.5 Capacitance-temperature characteristics

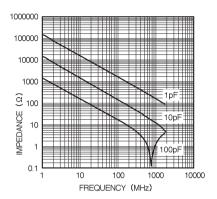


Fig.2 Impedance-frequency characteristics

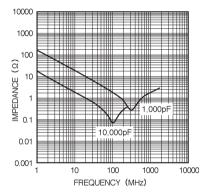


Fig.4 Impedance-frequency characteristics

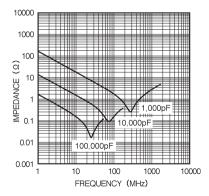
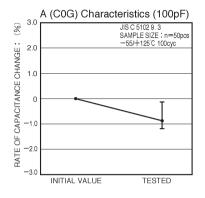
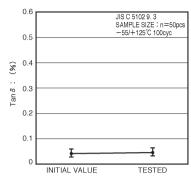


Fig.6 Impedance-frequency characteristics

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.

#### ■Temperature cycling test





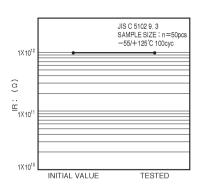
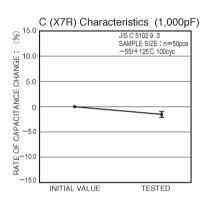
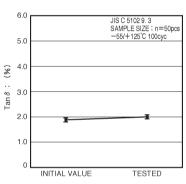


Fig.7 Rate of capacitance change

Fig.9 Insulation resistance





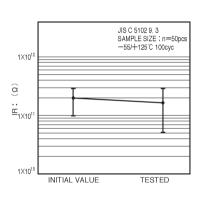
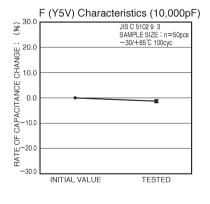
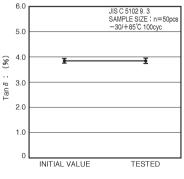


Fig.10 Rate of capacitance change

Fig.11 Tan δ

Fig.12 Insulation resistance





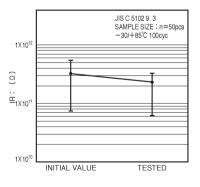


Fig.13 Rate of capacitance change

Fig.14 Tan δ

Fig.15 Insulation resistance

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.

#### ■ High-temperature load test

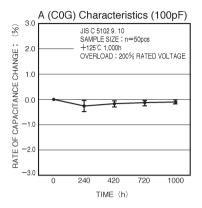


Fig.16 Rate of capacitance change

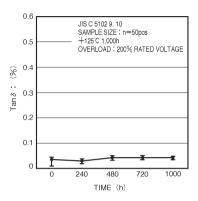


Fig.17 Tan  $\delta$ 

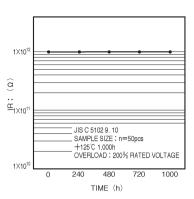


Fig.18 Insulation resistance

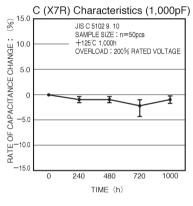


Fig.19 Rate of capacitance change

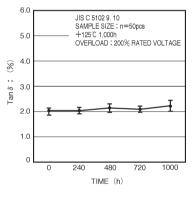


Fig.20 Tan  $\delta$ 

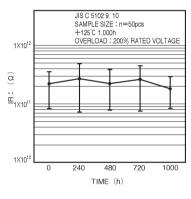


Fig.21 Insulation resistance

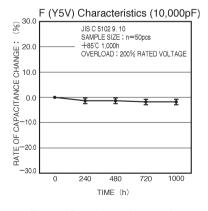


Fig.22 Rate of capacitance change

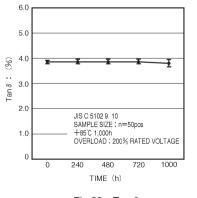


Fig.23 Tan  $\delta$ 

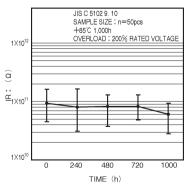
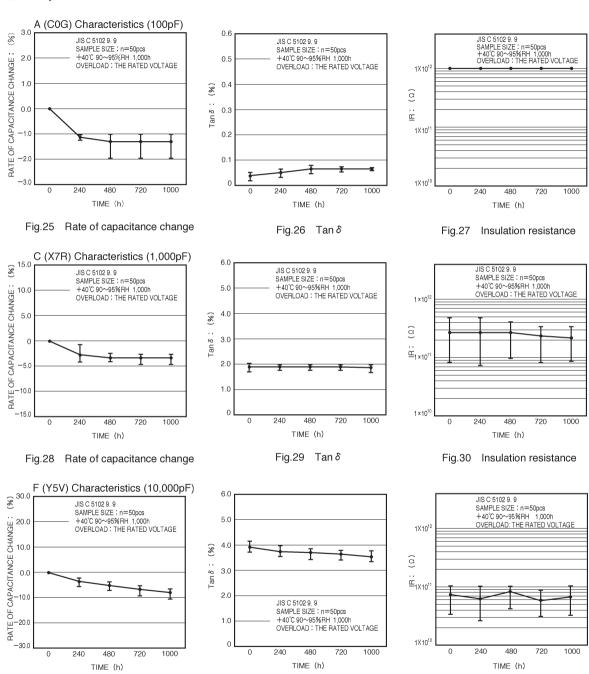


Fig.24 Insulation resistance

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.

#### Humidity load test



<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.

Fig.32 Tan δ

Fig.33

Insulation resistance

Fig.31

Rate of capacitance change